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RF360 Europe GmbH

Data sheet

SAW duplexer LTE / 5G band 28b

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1 Application

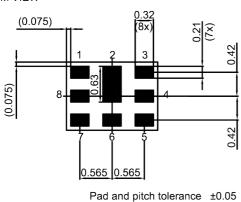
- Low-loss SAW duplexer for mobile telephone for 4G and 5G band 28.
- LTE band 28b uplink: 733 MHz (pass band 30 MHz)
- LTE band 28b downlink: 788 MHz (pass band 30 MHz)
- Qualcomm® micro-Acoustic Power Management (MAPM)
- Low insertion attenuation
- Duplexer for higher part of Band 28
- Usable pass band 30 MHz

2 Features

- Package size 1.6±0.05 mm × 1.2±0.05 mm
- Package height 0.6 mm (max.)
- Approximate weight 3 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)

3 Package

BOTTOM VIEW

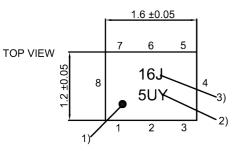


4 Pin configuration

- ∎ 1 RX
- 3 TX
- 6 ANT
- 2, 4, 5, 7, Ground 8

SIDE VIEW





1) Marking for pad number 1

2) Example of encoded lot number

3) Example of encoded filter type number

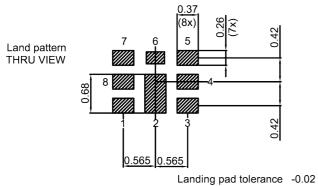
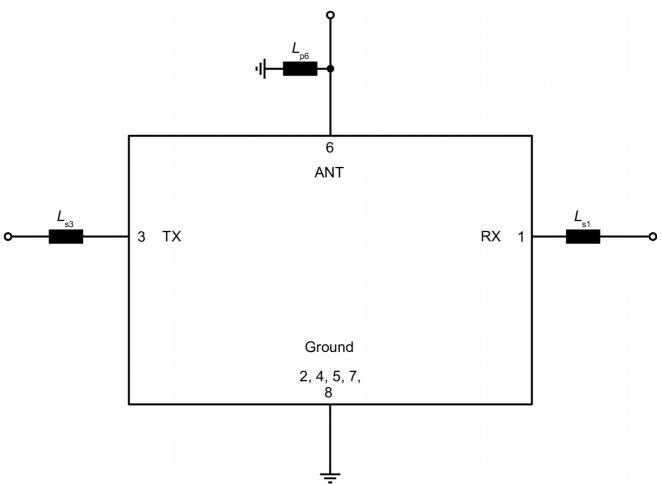


Figure 1: Drawing of package with package height A = 0.6 mm (max.). See Sec. Package information (p. 23).

5 Matching circuit

- *L*_{p6} = 9.0 nH
- *L*_{s1} = 3.9 nH



■ *L*_{s3} = 21 nH

Figure 2: Schematic of matching circuit.

External shunt inductor for ESD protection is recommended at any ports towards antenna.

6 Characteristics

6.1 TX – ANT

Temperature range for specification	T _{SPEC}	= −30 °C +85 °C
TX terminating impedance	Z _{TX}	= 50 Ω + 21 nH ¹⁾
ANT terminating impedance	Z	= 50 Ω // 9.0 nH ¹⁾
RX terminating impedance	Z _{RX}	= 50 Ω + 3.9 nH ¹⁾

Characteristics TX – ANT				min. for $T_{_{\rm SPEC}}$	typ. @ +25 °C	max. for $T_{\rm SPEC}$	
Center frequency			f _c	—	733	—	MHz
Maximum insertion attenuation			$\alpha_{_{max}}$				
	718.24 747.76	MHz		_	1.2	2.0 ²⁾	dB
	718.24 747.76	MHz		—	1.2	2.0	dB
Amplitude ripple (p-p)			Δα				
	718.24 747.76	MHz		—	0.7	1.5	dB
Maximum VSWR			VSWR _{max}				
@ TX port	718 748	MHz		—	1.5	2.0	
@ ANT port	718 748	MHz		—	1.5	2.0	
Average attenuation			$\alpha_{_{avg}}$				
	470 702	MHz		30	38	_	dB
Minimum attenuation			α _{min}				
	10 698	MHz		30	38	_	dB
	698 710	MHz		15	41	_	dB
	758.24 772.76	MHz		30	60	_	dB
	773.24 802.76	MHz		50	56	_	dB
	791 821	MHz		30	35	_	dB
	859 894	MHz		30	36	_	dB
	925 960	MHz		30	32	_	dB
	1166 1187	MHz		37	39	—	dB
	1226 1250	MHz		37	41	_	dB
	1406 1510.9	MHz		35	46	—	dB
	1559 1563	MHz		35	52	—	dB
	1565.42 1573.37	MHz		35	52	—	dB
	1573.37 1577.47	MHz		35	52	—	dB
	1577.47 1585.42	MHz		35	52	_	dB
	1597.55 1605.89	MHz		35	53	—	dB
	1710 1785	MHz		30	55	—	dB
	1805 1880	MHz		30	57	—	dB
	1930 1995	MHz		30	58	_	dB
	2010 2025	MHz		30	59	—	dB
	2110 2200	MHz		30	57	_	dB
	2154 2244	MHz		35	58	—	dB
	2300 2400	MHz		30	62	—	dB

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Characteristics TX – ANT			min. for $T_{\rm SPEC}$	typ. @ +25 °C	max. for $T_{_{\rm SPEC}}$	
	2400 2484	MHz	35	68	—	dB
	2496 2690	MHz	35	67	_	dB
	2872 2991	MHz	30	68	_	dB
	3300 3800	MHz	30	64	_	dB
	3300 4200	MHz	30	62	_	dB
	4400 5000	MHz	30	61	_	dB
	4900 5950	MHz	20	50	_	dB

¹⁾ See Sec. Matching circuit (p. 6).

²⁾ Valid for typical temperature T = +25 °C.

³⁾ Over any channel with band width of 6MHz.

6.2 ANT – RX

Temperature range for specification	T _{SPEC}	= −30 °C +85 °C
TX terminating impedance	Z _{TX}	= 50 Ω + 21 nH ¹⁾
ANT terminating impedance	Z	= 50 Ω // 9.0 nH ¹⁾
RX terminating impedance	Z _{RX}	= 50 Ω + 3.9 nH ¹⁾

Characteristics ANT – RX				min. for $T_{_{\rm SPEC}}$	typ. @ +25 °C	max. for $T_{\rm SPEC}$	
Center frequency			f _c	—	788	—	MHz
Maximum insertion attenuation			$\alpha_{_{max}}$				
	773.24 802.76	MHz		_	1.5	2.0 ²⁾	dB
	773.24 802.76	MHz		_	1.5	2.0	dB
Amplitude ripple (p-p)			Δα				
	773.24 802.76	MHz		_	0.8	1.5	dB
Maximum VSWR			VSWR _{max}				
@ ANT port	773 803	MHz		_	1.6	2.0	
Blocker 1 @ RX port	773 803	MHz		_	1.6	2.0	
Minimum attenuation			$\alpha_{_{min}}$				
Blocker 3	10 699	MHz		40	55	_	dB
Blocker 4	45 65	MHz		50	90	—	dB
	703.24 732.76	MHz		30	60	—	dB
	718.24 747.76	MHz		50	63	—	dB
	814 835	MHz		7	15	—	dB
	835 870	MHz		30	37	—	dB
	870 2400	MHz		40	43	_	dB
	2400 2483	MHz		30	52	—	dB
	2496 2690	MHz		35	51	—	dB
	3300 3800	MHz		30	50	—	dB
	3300 4200	MHz		30	50	—	dB
	4400 5000	MHz		30	51	—	dB
	4900 5950	MHz		25	51	—	dB

1)

See Sec. Matching circuit (p. 6). Valid for typical temperature T = +25 °C. 2)

6.3 TX – RX

Temperature range for specification	$T_{_{\rm SPEC}}$	= −30 °C +85 °C
TX terminating impedance	Z _{TX}	= 50 Ω + 21 nH ¹⁾
ANT terminating impedance	Z _{ANT}	= 50 Ω // 9.0 nH ¹⁾
RX terminating impedance	Z _{RX}	= 50 Ω + 3.9 nH ¹⁾

Characteristics TX – RX				min. for $T_{_{\rm SPEC}}$	typ. @ +25 °C	max. for $T_{\rm SPEC}$	
Minimum isolation							
	718.24 747.76	MHz	$\alpha_{_{min}}$	55 ²⁾	62	_	dB
	718.24 747.76	MHz	$\alpha_{_{min}}$	55	62	_	dB
	773 803	MHz	$\alpha_{_{INT,min}}^{\qquad 3)}$	55 ²⁾	57	_	dB
	773 803	MHz	a ³⁾	55	57	_	dB

1)

2)

See Sec. Matching circuit (p. 6). Valid for typical temperature T = +25 °C. Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels. 3)

7 **Maximum ratings**

Storage temperature	$T_{\rm STG}^{1)} = -40 ^{\circ}{\rm C} \dots +85 ^{\circ}{\rm C}$	
DC voltage	$ V_{\rm DC} ^{2)} = 0 V (max.)$	
ESD voltage		
	V _{ESD} ³⁾ = 125 V (max.)	Machine model.
	V _{ESD} ⁴⁾ = 200 V (max.)	Human body model.
	V _{ESD} ⁵⁾ = 700 V (max.)	Charged device model.
Input power	P _{IN}	
@ TX port: 718 748 MHz	30 dBm	Continuous wave for 5000 h @ 50 °C.
@ TX port: 718 748 MHz	30 dBm	5 MHz LTE uplink signal 1 RB for 5000 h @ 50 °C.
@ TX port: 718 748 MHz	29 dBm	5 MHz 5G NR (CP-OFDM) 1 RB for 5000 h @ 50 °C.

1) Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

2) In case of applied DC voltage blocking capacitors are mandatory.

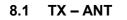
According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses. 3)

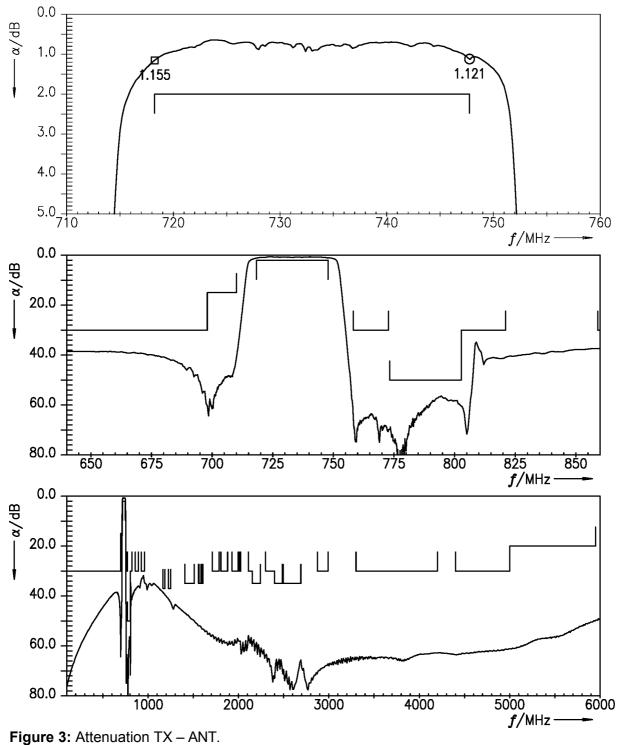
4)

According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse. According to JESD22-C101C (CDM – Field Induced Charged Device Model), 3 negative & 3 positive pulses. 5)



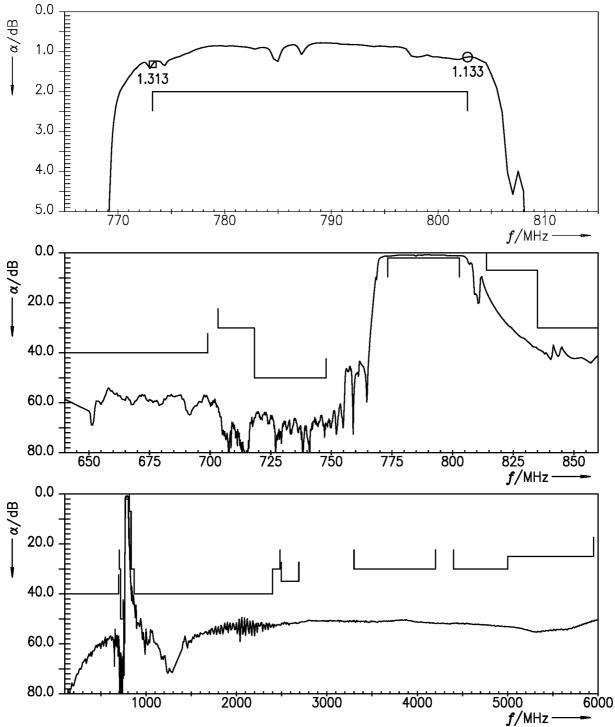
8 Transmission coefficients

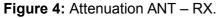




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8.2 ANT – RX





Please read **Cautions and warnings** and **Important notes** at the end of this document.

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8.3 TX – RX

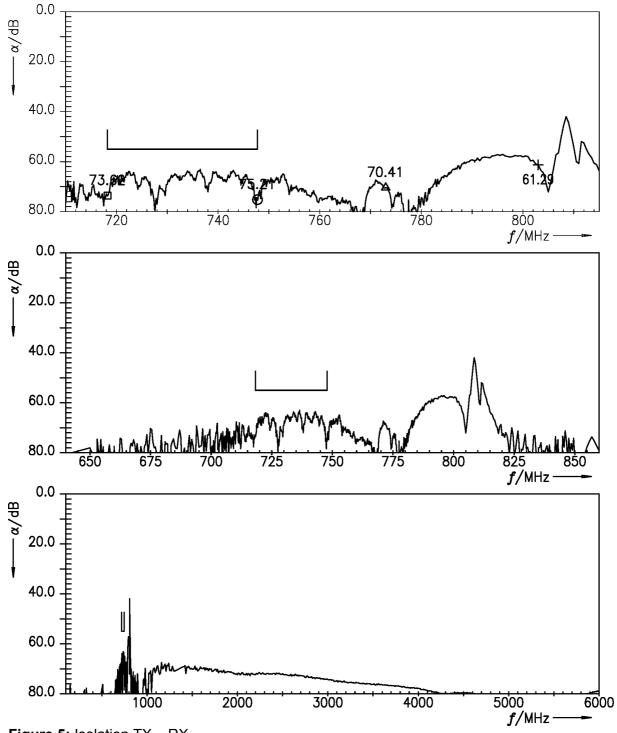


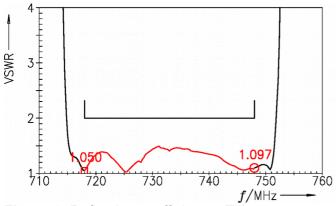
Figure 5: Isolation TX – RX.

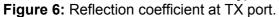
Please read **Cautions and warnings** and **Important notes** at the end of this document.



□ = 718.0 O = 748.0

9 Reflection coefficients





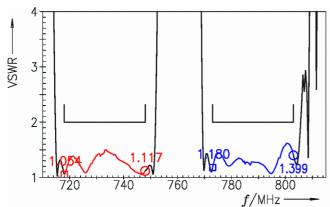
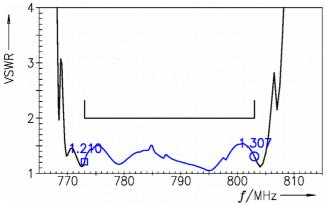
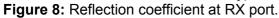
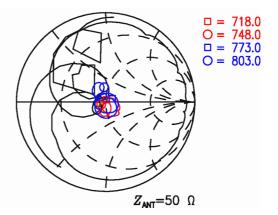


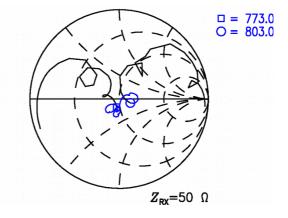
Figure 7: Reflection coefficient at ANT port.







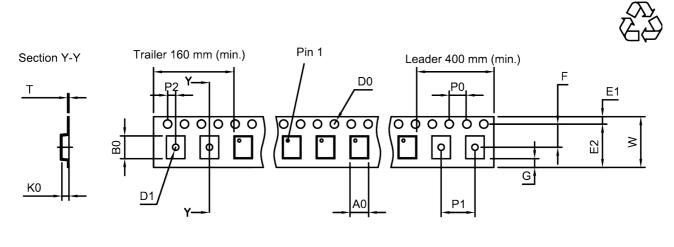
*Z*_{TX}=50 Ω





10 Packing material

10.1 Tape



User direction of unreeling

Figure 9: Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

 $\begin{array}{c} A_0 \\ B_0 \\ 1.8_{\pm 0.05} \mbox{ mm} \\ D_0 \\ 1.5_{\pm 0.1/-0} \mbox{ mm} \\ D_1 \\ 0.6_{\pm 0.1/-0} \mbox{ mm} \\ E_1 \\ 1.75_{\pm 0.1} \mbox{ mm} \end{array}$

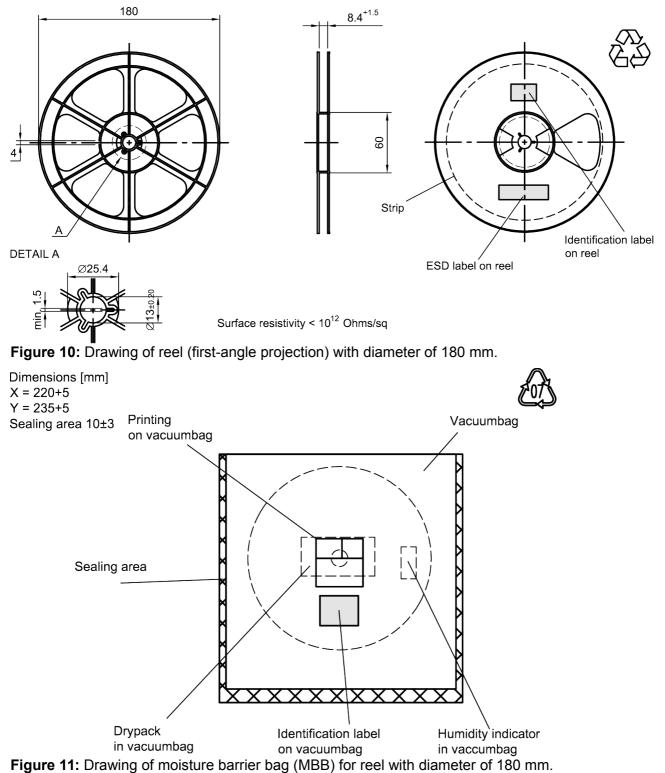
Table 1: Tape dimensions.

E2	6.25 mm (min.)
F	3.5±0.05 mm
G	0.75 mm (min.)
K ₀	0.7±0.05 mm
P ₀	4.0±0.1 mm

P ₁	4.0±0.1 mm
P ₂	2.0±0.05 mm
Т	0.25±0.03 mm
W	8.0+0.3/-0.1 mm



10.2 Reel with diameter of 180 mm



Please read **Cautions and warnings** and **Important notes** at the end of this document.

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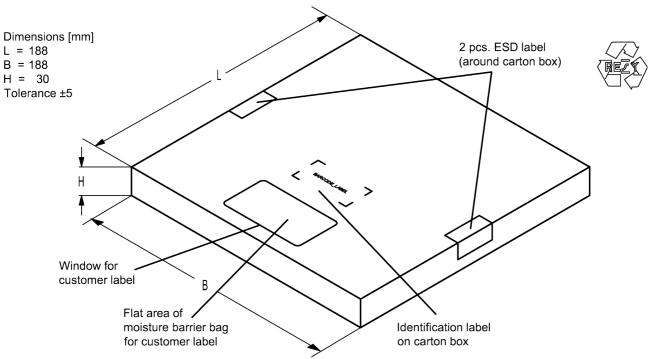
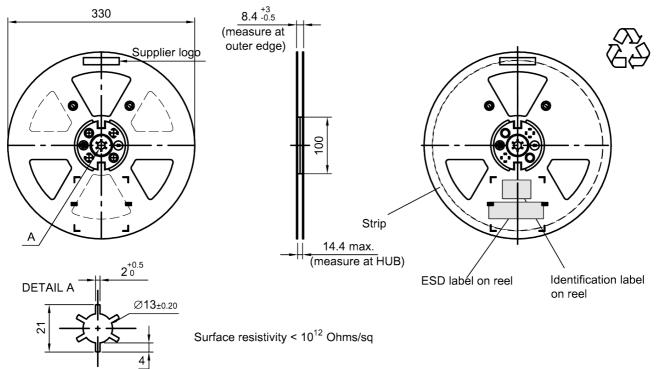
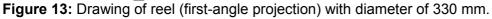


Figure 12: Drawing of folding box for reel with diameter of 180 mm.

10.3 Reel with diameter of 330 mm







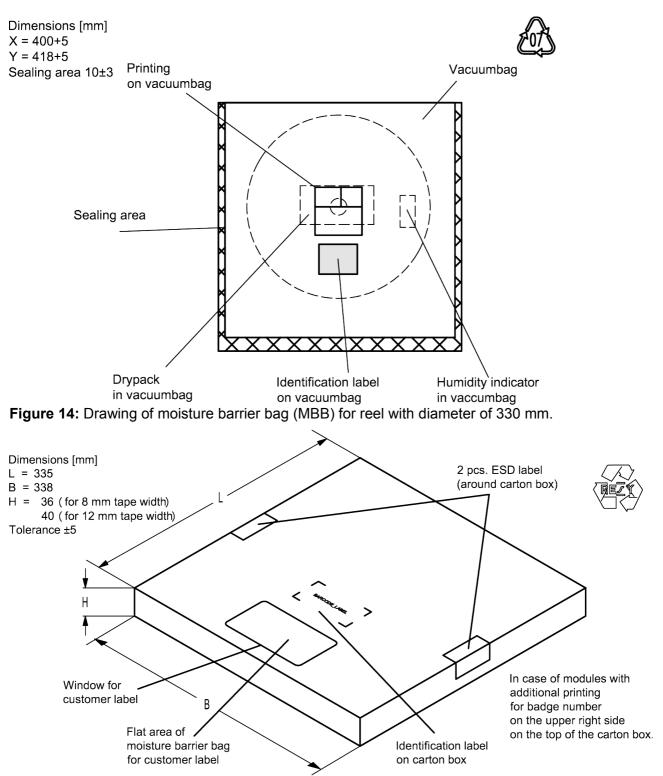


Figure 15: Drawing of folding box for reel with diameter of 330 mm.

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11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the or is encoded by a special BASE32	e.g., B3xxxxB <u>1234</u> xxxx,
Example of decoding type r 16J 1 x 32^2 + 6 x 32^1 + 1 The BASE32 code for product ty	in decimal code. 1234 1234

■ Lot number:

The last 5 digits of the lot number,e.g.,**12345**,are encoded based on a special BASE47 code into a 3 digit marking.12345,

Example of decoding lot number marking on device **5UY**

5UY	=>	12345
5 x 47 ² + 27 (=U) x 47 ¹ + 31 (=Y) x 47 ⁰	=	12345

Adopted BASE32 code for type number			
Decimal	Base32	Decimal	Base32
value	code	value	code
0	0	16	G
1	1	17	Н
2	2	18	J
3	3	19	K
4	4	20	М
5	5	21	N
6	6	22	Р
7	7	23	Q
8	8	24	R
9	9	25	S
10	А	26	Т
11	В	27	V
12	С	28	W
13	D	29	Х
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal	Base47	Decimal	Base47
value	code	value	code
0	0	24	R
1	1	25	S
2	2	26	Т
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	Α	34	d
11	В	35	f
12	С	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	Н	41	١
18	J	42	?
19	К	43	{
20	L	44	}
21	М	45	<
22	N	46	>
23	Р		

in decimal code.

 Table 2: Lists for encoding and decoding of marking.

12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
<i>T</i> > 220 °C	30 s to 70 s
<i>T</i> > 230 °C	min. 10 s
<i>T</i> > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

 Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

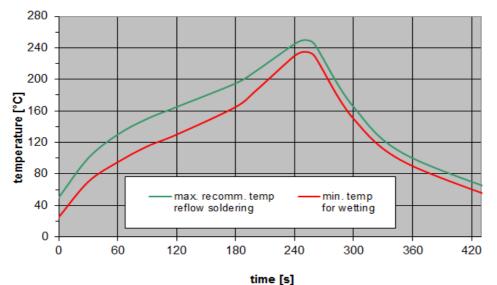


Figure 16: Recommended reflow profile for convection and infrared soldering – lead-free solder.

13 Annotations

13.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

13.3 Ordering codes and packing units

Ordering code	Packing unit
B39791B1279L210	15000 pcs
B39791B1279L210 5	5000 pcs

Table 4: Ordering codes and packing units.

14 Cautions and warnings

14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under https://rffe.qualcomm.com/.

14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.



15 Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (<u>https://rffe.qualcomm.com</u>). Should you have any more detailed questions, please contact our sales offices.
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